PTO/SB/01 (05-03)

Approved for use through 04/30/2003.OMB 0651-0032

AMK-BK-00001

Sung Soon Park

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**Attorney Docket Number** 

First Named Inventor

**DECLARATION FOR UTILITY OR** 

**DESIGN** 

PATENT APPLICATION

	(37 CI	FR 1.63)		Applica	tion Number File		ed Herewith							
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(h	ereby declare that:													
	ch Inventor's residence	•		•										
	I believe the inventor(s) named below to be the original and first inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled:													
	SEMICONDUCTOR PACKAGE STRUCTURE REDUCING WARPAGE AND MANUFACTURING METHOD THEREOF													
'	(Title of the Invention)													
	the specification of which is attached hereto OR													
	as United States Application Number or PCT International													
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	reby state that I have nded by any amendme			contents	of the above-ide	entified speci	fication, including	the claims, as						
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[Page 1 of 2]

This collection of informalion is required by 37 CFR 116 and 37 CFR 1.63. The information is required to obtain or rotain a benefit by the public which is to file (and by the USPTO to process) an application. Confridentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 21 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO Time will vary depanding upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer. U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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## **DECLARATION** — Utility or Design Patent Application

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of the application is not designated in the prior United States or PCT international application in the manner provided by the first paragraph of 31 U.S.C. 112. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

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U.S. Parent Application or PCT Parent Number						Parent Filing Date				Parent Patent Number					
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As a named inventor, I here	by appoint th	e followi	ing regi	stered	l pra	ctition	er(s) (	o prose				_			ct all
business in the Patent and Trademark Office connected therewith:   OR Registered practitioner(s) name/registration number listed below  Place Customer Number  OR Registered practitioner(s) name/registration number listed below															
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believed to be true; and further	I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the										ie are				
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## DECLARATION

ADDITIONAL INVENTOR(S)
Supplemental Sheet

		Page 1 of 1											
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